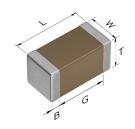
积层贴片陶瓷片式电容器

C1608X5R1C685K080AB

RoHS Reach Halogen Free Pb Free

交货型号	C1608X5R1C685KT****
用途	一般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	▲ 量产体制(新设计非推荐)



	尺寸
长度(L)	1.60mm ± 0.20 mm
宽度 (W)	0.80mm ±0.20mm
厚度(T)	0.80 mm ± 0.20 mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)
]世代/平飾/甲/町 (L M)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)
J世代/平価/甲/町(LD)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)
1世代 戸 徳 印 四 (1 0)	0.60mm to 0.80mm(Reflow Soldering)

Į.	1气特性
电容	6.8 μF ±10%
额定电压	16VDC
温度特性	X5R (±15%)
耗散因数(Max.)	10%
绝缘电阻 (Min.)	$14 \text{M}\Omega$

	其他	
焊接方法	流体	
件按月伝	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

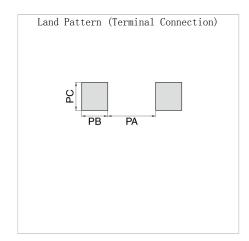
[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free

Associated Images



[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.